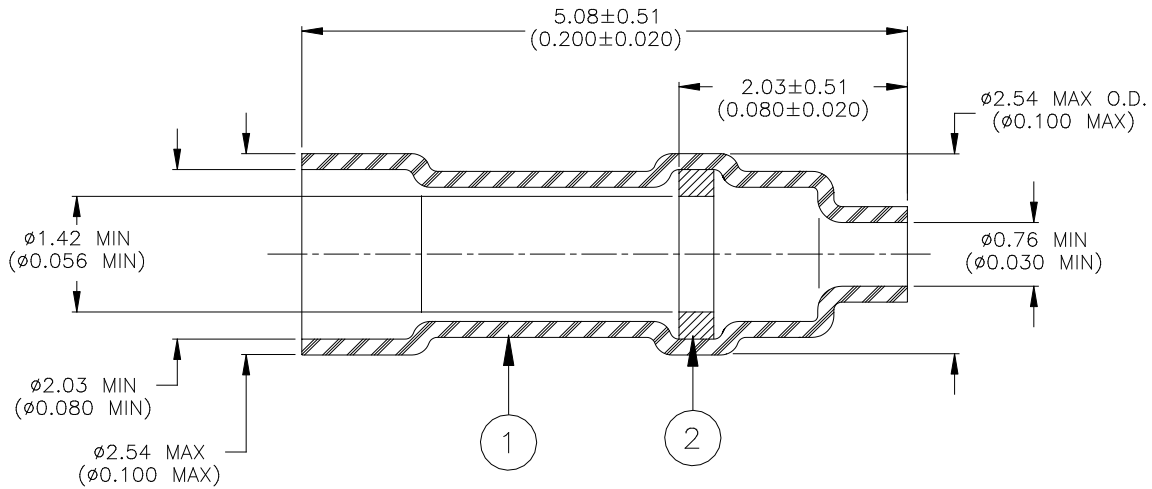


CUSTOMER DRAWING




MATERIALS

1. INSULATION SLEEVE: Heat shrinkable, transparent blue, radiation cross-linked polyvinylidene fluoride.
2. SOLDER PREFORM WITH FLUX:
 - SOLDER: TYPE Sn63 per ANSI J-STD-006.
 - FLUX: TYPE ROL0 per ANSI J-STD-004.

APPLICATION

1. This part is designed for terminating 26 and 22 AWG wire to Burndy UPC connectors.
2. The sleeve is designed for those applications where headroom above the connector pin is limited.

| | | | | | |
|--|---|--|---------------|---|----------------------|
|  | | Raychem THERMOFIT DEVICES | | TITLE: SOLDERSLEEVE, STEPPED INSULATION For Burndy UPC Connector, 0.69 x 02.54 (0.027 x 0.100) pins | |
| Unless otherwise specified dimensions are in millimeters. [Inches dimensions are shown in brackets] | | | | DOCUMENT NO.: D-141-19 | |
| TOLERANCES: 0.00 N/A 0.0 N/A 0 N/A | ANGLES: N/A ROUGHNESS IN MICRON | TE Connectivity reserves the right to amend this drawing at any time. Users should evaluate the suitability of the product for their application. | | REV: 2 | DATE: 09-Mar-2020 |
| DRAWN BY: M. FORONDA | DATE: 17-July-2000 | ECO: ECO-20-003687 | SCALE: NTS | SIZE: A | SHEET: 1 of 1 |

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